Docket No.: JCLA37607-CIP

→→ USPTO Assignment **700490811** 

Form 1595 (Rev. 09/04) RECORDATION FORM ( PATENTS ONL)	Patent and Trademark Office
To the Director of the U.S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.	
Names(s)  Tseng, Wei-Kai  Mar. 15, 2012	HIMAX TECHNOLOGIES LIMITED  No.26, Zilian Rd., Xinshi Dist., Tainan City 74148, Taiwan
3. Nature of conveyance: ☒ Assignment ☐ Merger ☐ Security Agreement ☐ Other ☐ Change of Name ☐ Reassignment	Add'I name(s)/address(es) of receiving parties Attached? □ Yes ☒ No
Application number(s) or patent number(s):     A. Patent Application No. (s)	B. Patent No. (s)
13/567,338	
Additional numbers attached?	☐ Yes ☒ No
5. Name and address of party to whom Correspondence concerning document should be mailed:	6. Total No. of applications and patents involved:
J. C. Patents 4, Venture Suite 250 Irvine, CA. 92618 Tel: (949) 660-0761 Fax: (949) 660-0809 E-mail: jcpi@msn.com	ONE(1)  7. Total fee (37 CFR §3.41): \$40.00  Authorized to be charge by credit card  Authorized to be charge to deposit account  Enclosed  None required (government interest not affecting title)  8. Payment Information  a. Credit Card Last Numbers  Expiration Date  b. Deposit Account Number 50-0710
Atty Docket No.: JCLA37607-CIP	Authorized User Name Jiawei Huang
9. Statement and Signature: To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.	
Jiawei Huang /JIAWEI HUANG/ Name of Person Signing Registration No. 43,330 Signature	August 6, 2012  Date  Total number of pages including cover sheet, attachments, and documents: 3

**PATENT REEL: 028726 FRAME: 0813**  HM-2011-0188-US 37607-US-PA-0P

## **ASSIGNMENT**

## WHEREAS,

Wei-Kai Tseng

hereinafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: STRUCTURE OF OUTPUT STAGE

[] Filed:

Serial No.

[x] Executed concurrently with the execution of this instrument

WHEREAS, HIMAX TECHNOLOGIES LIMITED

of No.26, Zilian Rd., Xinshi Dist., Tainan City 74148, Taiwan

hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

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## **ASSIGNMENT CONTINUED**

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

Signature: Wei-Kai Tseng Date: 2012. 3. 15

Sole or First Joint Inventor: Wei-Kai Tseng